MYC-C7Z010/007S CPU Module

- 667MHz Xilinx XC7Z007S or XC7Z010 ARM Cortex-A9 Processor with Xilinx 7-series FPGA logic
- 512MB DDR3 SDRAM (2 x 256MB, 32-bit), 4GB eMMC, 16MB QSPI Flash
- On-board Gigabit Ethernet PHY
- 1.27mm pitch 180-pin Stamp Hole Expansion Interface
- Ready-to-Run Linux 3.15.0
- Supports -40 to +85 Celsius Extended Temperature Operation for Industrial Applications

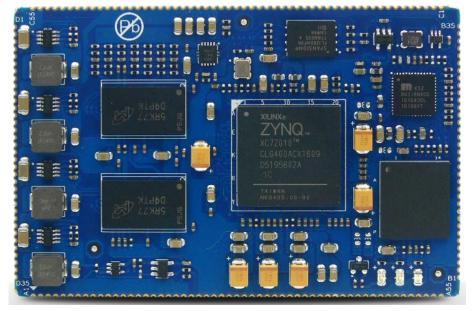


Figure 1-1 MYC-Y7Z010/007S CPU Module

The MYC-C7Z010/007S CPU Module is an industrial-grade System-on-Module (SoM) based on Xilinx Zvng-7000 family SoC available for either the XC7Z010 or XC7Z007S version. It has integrated the Zynq-7010 or 7007S device, 512MB DDR3 SDRAM, 4GB eMMC, 16MB quad SPI Flash, a Gigabit Ethernet PHY and external watchdog on board and provides 1.27mm 180-pin stamp-hole (Castellated-Hole) expansion interface to allow a large number of I/O signals for ARM peripherals and FPGA I/Os to be extended to your base board. The module is ready to run Linux and supports wide working temperature ranging from -40 to +85 Celsius which is ideal for industrial embedded applications.

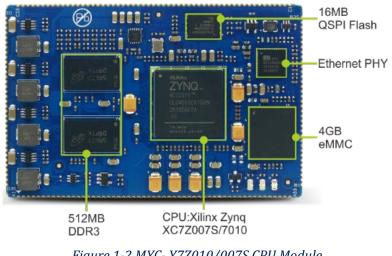
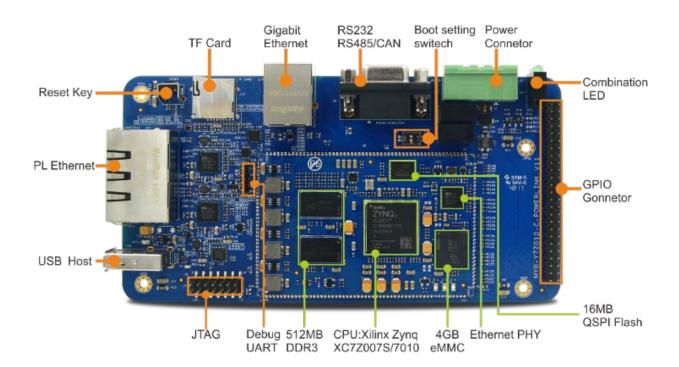
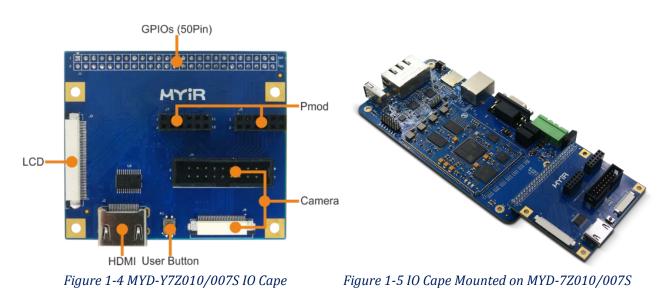


Figure 1-2 MYC- Y7Z010/007S CPU Module

MYIR provides a development board <u>MYD-Y7Z010/007S</u> for evaluating the <u>MYC-Y7Z010/007S CPU Module</u>, which employs the MYC-Y7Z010/007S as the controller board by populating the CPU Module on its base board through 1.27mm pitch 180-pin stamp-hole (Castellated-Hole) interface. The base board has extended a rich set of peripheral interfaces including serial ports, USB Host port, three Gigabit Ethernet ports, CAN, TF card slot, JTAG, etc. One 2.54mm pitch 2 x 25-pin expansion header is on the base board to let more GPIOs available for further extension. MYIR offers an optional <u>MYD-7Z010/007S IO CAPE</u> to connect to this expansion header to extend many peripherals and signals like HDMI, LCD, camera and Pmod to help user explore more functions. The 4.3- and 7-inch LCD Modules as well as MY-CAM011B camera module from MYIR can be supported through the IO Cape. Optional USB WiFi and Camera modules are also provided which supply user a complete evaluation platform for Zynq-7000.







Hardware Specification

The Zynq®-7000 All Programmable SoC (AP SoC) family integrates the software programmability of an ARM®-based processor with the hardware programmability of an FPGA, enabling key analytics and hardware acceleration while integrating CPU, DSP, ASSP, and mixed signal functionality on a single device. Consisting of single-core Zynq-7000S and dual-core Zynq-7000 devices, the Zynq-7000 family is the best price to performance-per-watt, fully scalable SoC platform for your unique application requirements.

Zynq-7000S

Zynq-7000S devices feature a single-core ARM Cortex[™]-A9 processor mated with 28nm Artix®-7 based programmable logic, representing the lowest cost entry point to the scalable Zynq-7000 platform. It includes Zynq Z-7007S, Z-7012S and Z-7014S which target smaller embedded designs. Available with 6.25Gb/s transceivers and outfitted with commonly used hardened peripherals, the Zynq-7000S delivers cost-optimized system integration ideal for industrial IoT applications such as motor control and embedded vision.

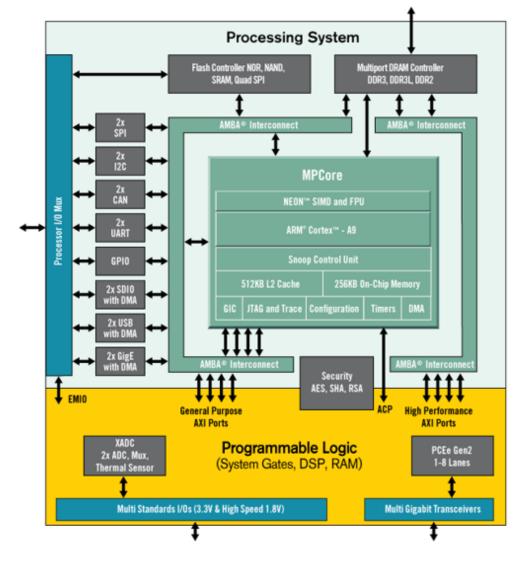


Figure 1-6 Zynq Z-7000S SoC Device Block Diagram

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MYIR TECH LIMITED

Zynq-7000

Zynq-7000 devices are equipped with dual-core ARM Cortex-A9 processors integrated with 28nm Artix-7 or Kintex®-7 based programmable logic for excellent performance-per-watt and maximum design flexibility. With up to 6.6M logic cells and offered with transceivers ranging from 6.25Gb/s to 12.5Gb/s, Zynq-7000 devices enable highly differentiated designs for a wide range of embedded applications including multi-camera drivers assistance systems and 4K2K Ultra-HDTV.

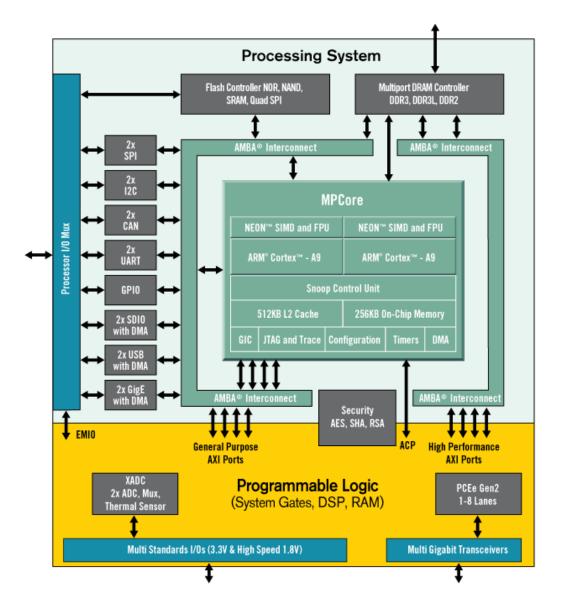


Figure 1-7 Zynq Z-7000 SoC Device Block Diagram

Zynq®-7000 All Programmable SoC Family

_	-											
			(Cost-Optimi	zed Device				Mid-Range Devices			
	Devi	ce Name	Z-7007S	Z-7012S	Z-7014S	Z-7010	Z-7015	Z-7020	Z-7030	Z-7035	Z-7045	Z-7100
	Part	Number	XC7Z007S	XC7Z012S	XC7Z014S	XC7Z010	XC7Z015	XC7Z020	XC7Z030	XC7Z035	XC7Z045	XC7Z100
	Processor Core		Single-Core Dual-Core ARM					Dual-Core ARM				
			ARM [®] Cortex [™] -A9 MPCore [™]			Cortex-A9 MPCore			Cortex-A9 MPCore			
			Up to 766MHz Up to 866MHz Up to 1GHz ⁽¹⁾									
2	Processor Ex	NEON™ SIMD Engine and Single/Double Precision Floating Point Unit per processor										
		L1 Cache	32KB Instruction, 32KB Data per processor									
		L2 Cache		512KB								
5	On-Chip	256KB										
1	External Memory Support ⁽²⁾		DDR3, DDR3L, DDR2, LPDDR2									
Processor Extensions L1 Cache L2 Cache On-Chip Memory External Memory Support ⁽²⁾ SEXTERNAL Static Memory Support ⁽²⁾ DMA Channels Peripherals												
	Peripherals w/ built-in DMA ⁽²⁾		2x USB 2.0 (OTG), 2x Tri-mode Gigabit Ethernet, 2x SD/SDIO RSA Authentication of First Stage Boot Loader,									
	S	ecurity ⁽³⁾	rity ⁽³⁾ AES and SHA 256b Decryption and Authentication for Secure Boot									
			2x AXI 32b Master, 2x AXI 32b Slave									
	Processing System to		Av AXI 64b/32b Memory									
	Programmable Logic Interface Ports		AXI 64b ACP									
	(Primary Interfaces & Interrupts Only)		16 Interrupts									
	7 Series PL Ec		Artix®-7	Artix-7	Artix-7	Artix-7	Artix-7	Artix-7	Kintex®-7	Kintex-7	Kintex-7	Kintex-7
		ogic Cells	23K	55K	65K	28K	74K	85K	125K	275K	350K	444K
Look-Up Tables (LUTs)		14,400	34,400	40,600	17,600	46,200	53,200	78,600	171,900	218,600	277,400	
Flip-Flops		28,800	68,800	81,200	35,200	92,400	106,400	157,200	343,800	437,200	554,800	
5	Total Block RAM		1.8Mb	2.5Mb	3.8Mb	2.1Mb	3.3Mb	4.9Mb	9.3Mb	17.6Mb	19.1Mb	26.5Mb
-		b Blocks)	(50)	(72)	(107)	(60)	(95)	(140)	(265)	(500)	(545)	(755)
-			66	120 Gen2 x4	170	80	160 Gen2 x4	220	400 Gen2 x4	900 Gen2 x8	900 Gen2 x8	2,020 Gen2 x8
	PCI Express [®] Analog Mixed Signal (AMS) / XADC ⁽²⁾		-	Genz x4	-			e with up to			Genz x8	Genz X8
	Security ⁽³⁾		2x 12 bit, MSPS ADCs with up to 17 Differential Inputs AES & SHA 256b Decryption & Authentication for Secure Programmable Logic Config									
-	Commercial		-1			-1		-1			-1	
-		xtended	-1		-2,-3			-2,-3			-2	
		ndustrial		-1, -2			-1, -2, -1L			-1, -2, -2L		-1, -2, -2L
		ndustrial		-1, -2			-1, -2, -1L			-1, -2, -2L		-1, -2, -21

 1.1 GHz processor frequency is available only for -3 speed grades for devices in flip-chip packages. See <u>DS190</u>, Zynq-7000 All Programmable SoC Overview for details.
 2. Z-7007S and Z-7010 in CLG225 have restrictions on PS peripherals, memory interfaces, and I/Os. Please refer to <u>UGS85</u>, Zynq-7000 All Programmable SoC Technical Reference Manual for more det 3. Security block is shared by the Processing System and the Programmable Logic.

Figure 1-8 Zynq Z-7000 and Z-7000S SoC Device Table

Mechanical Parameters

- ✓ Dimensions: 75mm x 50mm (10-layer PCB design)
- ✓ Power supply: 5V
- ✓ Working temp.: -40~85 Celsius (industrial grade)

SoC

✓ Xilinx XC7Z007S-1CLG400I (Zynq-7007S) or XC7Z010-1CLG400I (Zynq-7010)

- ARM® Cortex[™]-A9 MPCore processor

667MHz single-core processor (up to 766MHz, for XC7Z007S)

667MHz dual-core processor (up to 866MHz, for XC7Z010)

- Integrated Artix-7 class FPGA subsystem

with 23K logic cells, 14,400 LUTs, 66DSP slices (for XC7Z007S)

with 28K logic cells, 17,600 LUTs, 80 DSP slices (for XC7Z010)

- NEON™ & Single / Double Precision Floating Point for each processor

- Supports a Variety of Static and Dynamic Memory Interfaces

Memory

- ✓ 512MB DDR3 SDRAM (256MB*2)
- ✓ 4GB eMMC
- ✓ 16MB QSPI Flash

Peripherals and Signals Routed to Pins

MYC-Y7Z010/007S Pinouts Description

- ✓ 10/100/1000M Ethernet PHY
- ✓ External watchdog
- ✓ Three LEDs
 - One red LED for power indicator
 - One green LED for FPGA program done indicator
 - One green user LED for system indicator
- ✓ 1.27mm pitch 180-pin Stamp Hole Expansion Interface brings out below signals:
 - One Gigabit Ethernet
 - One USB
 - Two Serial ports
 - Two I2C
 - Two CAN BUS
 - Two SPI

* Serial ports, I2C, CAN and SPI signals in PS part can be implemented through PL pins via Emio.

- Two ADC (16-channel ADC brought out through PL pins)
- One SDIO

Function Block Diagram

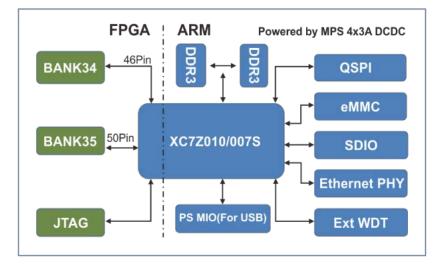


Figure 1-8 MYC-Y7Z010/007S Function Block Diagram

Dimension Chart

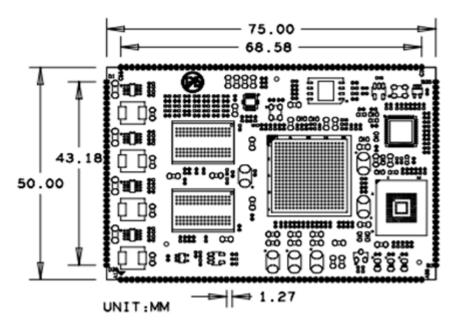


Figure 1-9 Dimensions of MYC-Y7Z010/007S

Software Features

The MYC-Y7Z010/007S CPU Module is capable of running Linux 3.15.0. MYIR provides software package in product disk along with the goods delivery. The software package features as below:

Item	Features	Description	Remark	
Cross		gcc version 4.6.1 (Sourcery CodeBench Lite		
compiler	gcc 4.6.1	2011.09-50)		
Boot	BOOT.BIN	First boot program including FSBL, bitstream	Source code provided	
program	u-boot	Secondary boot program	Source code provided	
Linux Kernel	Linux 3.15.0	Customized kernel for MYD-Y7Z010/007S	Source code provided	
	USB Host	USB Host driver	Source code provided	
	Ethernet	Gigabit Ethernet driver	Source code provided	
	MMC/SD/TF	MMC/SD/TF card driver	Source code provided	
	CAN	CAN driver	Source code provided	
	LCD Controller	XYLON LCD driver	Source code provided	
	HDMI	HDMI (SII902X chip) driver	Source code provided	
	Button	Button driver	Source code provided	
Drivers	UART	UART driver	Source code provided	
	LED	LED driver	Source code provided	
	GPIO	GPIO driver	Source code provided	
	QSPI	QSPI Flash W25Q128FW driver	Source code provided	
	RTC	DS3231 RTC driver	Source code provided	
	Resistive Touch	TSC2007 resistive touch screen driver	Source code provided	
	Capacitive Touch	FT5X0X capacitive touch screen driver	Source code provided	
	ADC	ADC driver	Source code provided	
File Grater	Ramdisk	Ramdisk system image		
File System	Rootfs.tar	Tar file		

Table 1-1 Linux Software Package Features

Order Information

Item	Part No.	Packing List			
MYC-Y7Z010 CPU Module	MYC-Y7Z010-4E512D-667-I	 One MYC-Y7Z010 CPU Module (for Zynq-7010) One Product Disk 			
MYC-Y7Z007S CPU Module	MYC-Y7Z007S-4E512D-667-I	 One MYC-Y7Z007S CPU Module (for Zynq-7007S) One Product Disk 			
MYD-Y7Z010 Development Board	MYD-Y7Z010-4E512D-667-I				
MYD-Y7Z007S Development Board	MYD-Y7Z007S-4E512D-667-I	Add-on Options:			
MY-WF003U WiFi Module	MY-WF003U				
MY-CAM002U Camera Module	MY-CAM002U	 MYD-Y7Z010/007S Board MY-LCD43TP LCD Module 			
MY-CAM011B Camera Module	MY-CAM011B	> MY-LCD70TP LCD Module			
MY-LCD43TP 4.3-inch LCD Module with resistive touch screen	MY-TFT043RV2	 MY-LCD70TP-C LCD Module MY-CAM002U Camera Module 			
MY-LCD70TP 7-inch LCD Module with resistive touch screen	MY-TFT070RV2	 MY-WF003U Camera Module MY-CAM011B Camera Module MVD V77010 (0075 IO CAPE 			
MY-LCD70TP-C 7-inch LCD Module with capacitive touch screen	MY-TFT070CV2	> MYD-Y7Z010/007S IO CAPE			
MYD-Y7Z010/007S IO CAPE	MY-CAPE003				

MYi**R**[®]

MYIR Tech Limited

Room 04, 6th Floor, Building No.2, Fada Road, Yunli Smart Park, Bantian, Longgang District, Shenzhen, Guangdong, China 518129 E-mail: sales@myirtech.com Phone: +86-755-22984836 Fax: +86-755-25532724 Website: http://www.myirtech.com

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